

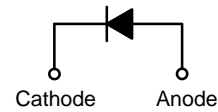
Silicon Carbide (SiC) Schottky Diode – EliteSiC, 30 A, 650 V, D2, D2PAK-2L

FFSB3065B-F085

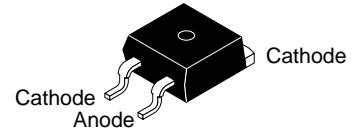
Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, automotive HEV/EV DCDC Converter, and more.

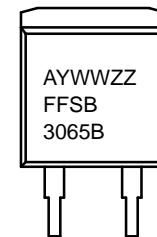
CASE 418BK



Schottky Diode



MARKING DIAGRAM



- | | |
|-----------|---------------------------|
| A | = Assembly Plant Code |
| YWW | = Date Code (Year & Week) |
| ZZ | = Lot Code |
| FFSB3065B | = Specific Device Code |

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FFSB3065B-F085

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	650	V

FFSB3065B-F085

TEST CIRCUIT AND WAVEFORMS

$L = 0.5 \text{ mH}$
 $R < 0.1 \Omega$
 $V_{DD} = 50 \text{ V}$
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)} / (V_{R(AVL)} - V_{DD})]$
 $Q1 = \text{IGBT (} BV_{CES} > \text{DUT } V_{R(AVL)} \text{)}$

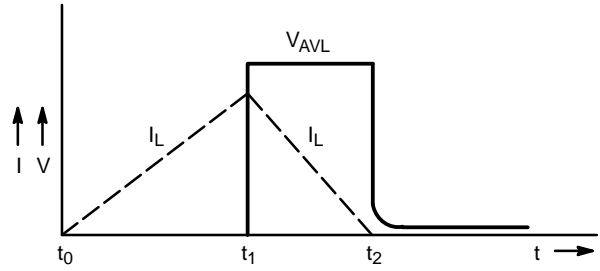
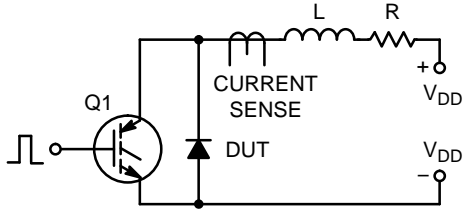
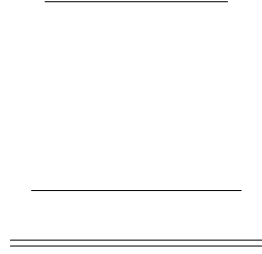
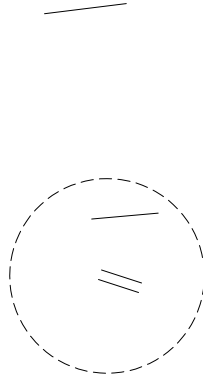


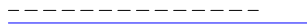
Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

D²PAK2 (TO-263-2L)
CASE 418BK
ISSUE O

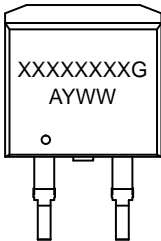
DATE 02 AUG 2018



DET/



**GENERIC
MARKING DIAGRAM***



- XXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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